A METHOD OF TESTING A SEQUENTIAL ACCESS MEMORY PLANE AND A CORRESPONDING SEQUENTIAL ACCESS MEMORY SEMICONDUCTOR DEVICE.

Field of the Invention

The invention concerns sequential access memories, in particular first in/first out (FIFO) memories, and especially testing such memories, using a
5 dedicated test circuit integrated during fabrication of the memory and the associated test algorithm.

Background of the Invention

At present, a test circuit integrated into a memory and an associated test algorithm, known to the
10 person skilled in the art as a built-in self-test (BIST) algorithm, write dedicated test words into the memory array on command and then extract them and compare the test bits of the extracted words with the expected binary data bits. This necessitates the use
15 of decoder logic which is connected to the output of the memory array and also receives the expected data, whose overall size increases as the width of the data bus of the memory increases, i.e. as the number of bits of the test words increases.
20   Also, in addition to this penalizing aspect of the overall surface area, this kind of decoder logic causes substantial problems with the hardware implementation ("routability") of the connections between the components of the decoder logic.

Summary of the Invention

The invention aims to address the above mentioned problems. An object of the invention is to provide a sequential access memory array test that allows a
5 particularly simple implementation leading to an extremely small overall size of the test logic.

The invention therefore provides a method of testing a sequential access memory plane adapted to store p words each of n bits. In this method p test
10 words each made up of n test bits are written in the memory array. The p test words are extracted from the memory plane and the test bits of the extracted words are compared with expected binary data bits. According to one general feature of the invention, the p test
15 words are extracted sequentially and, for each current word extracted, the n test bits that compose it are compared sequentially with n respective expected data bits before extracting the next test word.

In other words, unlike the conventional prior art
20 tests, in which the n bits of an extracted test word are compared simultaneously and in parallel with an expected data word, the sequential bit-by-bit comparison of each extracted word in accordance with the invention enables the use of extremely simple
25 comparison logic, for example including an EXCLUSIVE OR or EXCLUSIVE NOR logic gate.

In one embodiment of the method, the p test words each of n bits are written in such a way as to obtain a checkerboard test binary configuration in the memory
30 plane. The expected data is obtained sequentially from respective logical combinations of the read addresses of the test words and the ranks of the test bits in each word that is read. This kind of embodiment makes it extremely simple to generate the expected data.

35 The invention further provides a sequential access semiconductor memory device including a memory

array adapted to store p words each of n bits and test
logic connected to the n outputs of the memory array.
The test logic includes first test means for writing
into the array p test words each composed of n test
5 bits, and second test means for extracting the p test
words from the memory array and compare the test bits
of the extracted words with expected binary data bits.

According to one general feature of the
invention, the second test means extracts the p test
10 words sequentially and, for each current extracted
word, sequentially compares the n respective test bits
that compose it with n expected data bits, before
extracting the next test word.

In one embodiment of the invention, the second
15 test means include a set of n chained output registers
connected to n respective outputs of the memory plane,
first control means adapted to deliver a first control
signal to the n output registers so as to store
simultaneously in those n registers the n test bits of
20 the current test word, second control means adapted to
deliver to the n output registers a second control
signal so as to shift the test bit contained in a
register of the chain sequentially toward the next
register and to extract sequentially from the register
25 at the end of the chain the n test bits of the current
test word, and comparator means for comparing each bit
extracted from the register at the end of the chain
with the corresponding expected data bit.

For example, each output register is a D-type
30 flip-flop having a data input connected to one of the n
outputs of the memory plane, a test input, a test
output and a test control input for receiving
successively and alternately the first control signal
and the second control signal. The test output of a
35 flip-flop is connected to the test input of the
adjacent flip-flop to form the chain. The test input of
the first flip-flop of the chain is adapted to receive

an initial data bit (for example present at the output of another flip-flop or a register). Finally, the test output of the last flip-flop is connected to a first input of the comparator means. For example, the

5   comparator means can include an EXCLUSIVE OR logic gate, possibly associated with an inverter so that it is an EXCLUSIVE NOR circuit.

The output registers of a sequential access memory (for example an FIFO memory) are generally

10   already chained and connected in series with other chains of other blocks in the integrated circuit to form a test chain known to the person skilled in the art as a "scan chain". The invention is noteworthy in that it uses part of the scan chain to carry out the

15   test in accordance with the invention (BIST test).

In one embodiment of the invention, the first test means write the p test words each of n bits in such a manner as to obtain in the memory plane a checkerboard test binary configuration. The test logic

20   includes generator means which generates the expected data bits sequentially from respective logical combinations of the read addresses of the test words and the ranks of the test bits in each word that is read.

25   The generator means advantageously include first means for delivering the least significant bit of each read address, a counter for containing a binary word representative of the rank of a test bit in the current word extracted from the memory plane, second means for

30   delivering the least significant bit of each binary word containing the counter, and an EXCLUSIVE OR or EXCLUSIVE NOR logic gate with two inputs connected to respective outputs of the first and second means and whose output delivers the expected data bits

35   sequentially.

Brief Description of the Drawings

Other advantages and features of the invention will become apparent on examining the following detailed description, given by way of non-limiting
5   example, of an embodiment of the invention and the accompanying drawings, in which:

Figure 1 is a diagram showing one embodiment of a memory device according to the invention; and

Figure 2 is a timing diagram illustrating one
10   embodiment of the method according to the invention.

Detailed Description of the Preferred Embodiments

Figure 1 shows a sequential access memory device FF, for example an FIFO memory. The memory FF includes a memory array PMM able to store p words each of n
15   bits. In other words, the depth of the memory is equal to p and the width of the data bus is equal to n. In the example described here, for simplicity, $p = 4$ and $n = 3$. The figure shows the successive storage addresses a_i of the p words in the memory array PMM.

20   In the normal operating mode writing and reading are effected in the conventional manner using write and read pointers controlled in the conventional manner by control circuit/means CPT. A multiplexer MUXB controls the write and read pointers of the memory array in
25   response to a control signal RB from either the control means CPT (in the normal mode of operation) or the test mode control circuit/means MT1 (in the test mode of operation). Similarly, the data to be written into the memory array is selected via n multiplexers MUXi which
30   are also controlled by the control signal RB.

Accordingly, in the normal mode of operation, the n data bits DD on the bus are written into the memory array. In the test mode of operation, on the other hand, binary test data bits DT are written into the
35   memory plane PMM.

The control means or control circuit MT1 and the multiplexers MUXi and MUXB then form first test means

used, in conjunction with the test data bits DT, to write into the memory array p test words each made up of n test bits. Also, in a preferred embodiment, the first test means write the p test words of n bits in
5   such a way as to obtain a checkerboard test configuration in the memory plane. A checkerboard configuration, as shown in Figure 1, is one in which each test word includes alternating 0 and 1 bits, and wherein the 0 bits and the 1 bits of two words written
10   at successive addresses are mutually shifted by one bit.

The memory FF further includes n output registers BC0-BC2. Here the output registers are D-type flip-flops each having a data input D connected to one of
15   the n outputs of the memory plane PMM. Each flip-flop D also has a test input TI, a test output SO and a test control input TE. Furthermore, each flip-flop is clocked by a clock signal CK. Finally, each flip-flop has a data output Q.
20   In the normal mode of operation the n data bits extracted from the memory PMM are delivered to the respective n data inputs D of the flip-flops and then to the n data outputs Q in time with the rising edges of the clock signal CK. This is not the case in the
25   test mode of operation, however, as explained next in more detail.

As well as being connected to n respective outputs of the memory plane PMM by their data input D, the n flip-flops are chained. To be more precise, the
30   test output SO of one flip-flop, for example the flip-flop BC1, is connected to the test input TI of the adjacent flip-flop, here the flip-flop BC0, for example, to form a chain. The test input TI of the first flip-flop BC2 in the chain is connected to
35   storage means containing an initial data bit DDI. The value of the initial data bit is immaterial, as explained in more detail below. The storage means can

be the output of another flip-flop of another component
of the integrated circuit, for example. The input TI of
the first flip-flop BC2 can equally be hardwired to
ground.

5   All the test control inputs TE receive a signal
CB from the control means or control circuit MCD. When
the signal CB takes the value 0, for example, it
constitutes a first control signal and a data bit at
the input D of a flip-flop is then delivered to the

10 output SO on the next rising edge of the clock CK. On
the other hand, when the signal CB takes the value 1,
it constitutes a second control signal and, in this
case, each flip-flop delivers the data bit at the test
input TI to the output SO in time with the rising edges

15 of the clock signal CK. The structure and operation of
this kind of D-type flip-flop, i.e. one also having a
test input, a test output and a test control input, are
well known to the person skilled in the art.

          Comparator means are further provided, here in

20 the form of a EXCLUSIVE NOR logic gate PL2. A first
input of the logic gate PL2 is connected to the test
output SO of the flip-flip BC0 at the end of the chain.
The other input of the logic gate PL2 receives the
expected data bits DAi sequentially. The output of the

25 logic gate PL2 is a logic signal that takes the value 0
or 1 in time with the comparison operations and as a
function of their result.

          If a checkerboard test configuration is used,
there is a very simple way to generate the expected

30 data bits DAi, as shown in the lower part of Figure 1.
To be more precise, this entails logically combining
the least significant bit LSB of the read address ai of
the test word that is read and the least significant
bit LSB of the rank ngi of the test bit that is read in

35 the word concerned. Specifically, if, for example, as
shown in figure 1, the read address a0 is the binary
address 00, the read address a1 is the binary address

01, the read address a2 is the binary address 10, and
the read address a3 is the binary address 11, the first
means or circuit M1 that deliver the least significant
bit of each read address deliver the value 0 for the
5   test word at the address a0.

     A counter CT, incremented in time with the clock
signal CK, counts from 0 to n - 1. Assuming that the
value 0 is representative of the rank of the test bit
DT0, the least significant bit of the value of the
10   counter is equal to 0 for the test bit DT0, 1 for the
test bit DT1, and 0 for the test bit DT2. Logically
combining the least significant bit LSB (ai) of the
read address and the least significant bit LSB (rgi) of
the counter value in the EXCLUSIVE NOR logic gate PL1
15   supplies sequentially the values 1, 0 and 1
corresponding to the test word at the address a0 in the
memory plane PMM. Of course, if the test word stored
at the address a0 had been 0 1 0, the logic gate PL1
would simply have been an EXCLUSIVE OR gate.

20   The test on the memory plane PMM is described in
more detail next with more particular reference to
Figure 2. The control means MCD that deliver the clock
signal CK first assign the value 0 to the signal CB
(the first control signal). Consequently, on the
25   occurrence of the first rising edge of the clock CK1,
the test data bits DT0, DT1 and DT2 of the test word
stored at the address a0 are delivered simultaneously
to the respective test outputs SO of the flip-flops
BC0, BC1 and BC2. In the same cycle, the data bit DT0
30   available at the test output SO of the flip-flop BC0 is
compared in the logic gate PL2 to the expected data bit
DA0. The result of the comparison is indicated by the
value FA0 of the signal FAi.

     In the same clock signal cycle, the data bit DT2
35   is available at the test input TI of the flip-flop BC1
and the test data bit DT1 is available at the test
input TI of the flip-flop BC0. The control means MCD

change the state of the signal CB (the second control
signal) to 1 after the rising edge CK1 of the clock
signal, and before the next rising edge CK2.
Accordingly, on the next rising edge CK2 of the clock
5 CK, the data bits available at the test outputs SO of
the flip-flops are shifted toward the flip-flop at the
end of the chain.

To be more precise, the initial data bit DDI is
then available at the output SO of the flip-flop BC2,
10 the test data bit DT2 is available at the test output
SO of the flip-flop BC1 and the test data bit DT1 is
available at the test output SO of the flip-flop BC0
and can then be tested by comparing it in the logic
gate PL2 with the corresponding expected data bit DA1.
15 The signal CB is still at 1 on the next rising edge CK3
of the clock. Thus at this time the data bit DT2 is
available at the test output SO of the flip-flop BC0
and can be compared in the logic gate PL2 with the
expected data bit DA2.
20 At this time, the whole of the test word stored
in the memory plane PMM at the read address a0 has been
tested. To test the next test word, stored at the read
address a1 and now available at the output of the
memory plane PMM, the control means MCD change the
25 value of the signal CB to 0. The result is that on the
next rising edge CK4 of the clock signal, the test bits
DT2, DT1 and DT0 of the next test word are available at
the test outputs SO of the flip-flops BC2, BC1 and BC0.
Then, after this rising edge CK4 of the clock
30 signal, the signal CB is again set to logic 1 and the
process of shifting and sequentially testing the test
bits of the test word is effected in a similar manner
to that just described for the preceding test word. It
should therefore be noted here that the initial data
35 bit DDI is never involved in the test and consequently
its value is immaterial.

The invention therefore provides a very simple memory plane test which is carried out at the normal operating frequency of the circuit and uses extremely simple and compact test logic.

5   The invention is not limited to the embodiments and uses that have just been described, but embraces all variants thereof. For example, the test according to the invention could easily be applied to a last in/first out (LIFO) sequential access memory.